

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT7185782

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SANG-YONG PARK	01/24/2022
JIN-HONG PARK	01/24/2022
SUNGJOO LEE	01/04/2022
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
Name:	RESEARCH AND BUSINESS FOUNDATION SUNGKYUNKWAN UNIVERSITY
Street Address:	2066, SEOBU-RO, JANGAN-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17666448
CORRESPONDENCE DATA	
Fax Number:	(703)563-0600
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(703)757-7880
Email:	pto@muirpatentlaw.com
Correspondent Name:	MUIR PATENT LAW, PLLC
Address Line 1:	P.O. BOX 1213
Address Line 4:	GREAT FALLS, VIRGINIA 22066
ATTORNEY DOCKET NUMBER:	SAM-59233MAS
NAME OF SUBMITTER:	SANG KI HWANG
SIGNATURE:	/Sang Ki Hwang/
DATE SIGNED:	02/20/2022

Total Attachments: 4

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**COMBINED DECLARATION (37 CFR § 1.63) FOR UTILITY PATENT APPLICATION AND
ASSIGNMENT FORM¹**

The undersigned acknowledges that this document is being used both as an assignment of the invention and as the declaration (37 CFR § 1.63) for a Utility or Design Application.

WHEREAS, the undersigned, hereinafter referred to individually and collectively as Assignor, has invented:

Title: SEMICONDUCTOR MEMORY DEVICE AND OPERATING METHOD THEREOF

for which Assignor is about to make or has made United States or International application for patent.

WHEREAS, as a below named inventor(s), I/(we) hereby declare that:

Section I. Declaration

This declaration is directed to:

- ☒ The attached U.S. non-provisional patent application, or
☐ U.S. non-provisional patent application number _____, filed on _____, or
☐ PCT international patent application number _____, filed on _____.

The above-identified application was made or authorized to be made by me (us).

I (we) believe that I am (we are) the original inventor (original joint inventors) of a claimed invention in the above-identified application.

I (we) hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

I (we) hereby state that I (we) have reviewed and understand the contents of the above identified application, including the claims.

I (we) acknowledge that I (we) am (are) aware of the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56.

¹ This form requires the use of an Application Data Sheet.

SEC Ref No. IC-202009-001-1-US0

Attorney Ref No. SAM-59233MAS

Section II. Assignment

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned hereby sell(s) and assign(s) to

Samsung Electronics Co., Ltd.

having an address at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do 16677, Republic of Korea, and

RESEARCH & BUSINESS FOUNDATION SUNGKYUNKWAN UNIVERSITY

having an address at 2066, Seobu-ro, Jangan-gu, Suwon-si, Gyeonggi-do, Republic of Korea, (hereinafter designated as Assignees), the entire (100%) right, title and interest for the United States as defined in 35 U.S.C. § 100, in the invention described in the application identified in Section I of this document.

Assignor hereby confirms any prior assignment to Assignees, and to the extent that Assignor has not already done so, agrees to assign, and hereby does, sell, assign and transfer unto Assignees and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignees to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignees without further or other compensation than that above set forth;

SEC Ref No. IC-202009-001-1-US0

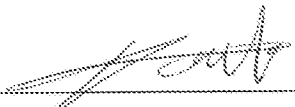
Attorney Ref No. SAM-59233MAS

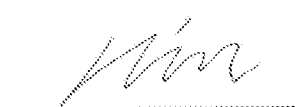
Assignor hereby covenants that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

Assignor hereby requests the United States Patent and Trademark Office to issue the Letters Patent of the United States of America to Assignees, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue the Letters Patent, Utility Model Registration or other similar right to Assignees.

The undersigned hereby grant(s) the law firm of Muir Patent Law, PLLC the power to insert on this Declaration and Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

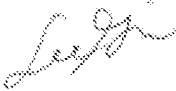
Section III. Inventor(s)/Assignor(s) Signature(s)

LEGAL NAME OF FIRST INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	PARK	Sang-Yong	
<p>SIGNATURE  DATE <u>22/1/24</u></p>			

LEGAL NAME OF SECOND INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	PARK	Jin-Hong	
<p>SIGNATURE  DATE <u>22/1/24</u></p>			

SEC Ref No. IC-202009-001-1-US0 Attorney Ref No. SAM-59233MAS

LEGAL NAME OF THIRD INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	LEE	Sungjoo	

SIGNATURE		DATE	January 4, 2022
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SEC Ref No. IC-202009-001-1-US0 Attorney Ref No. SAM-59233MAS